SN54AHC273, SN74AHC273 OCTAL D-TYPE FLIP-FLOPS WITH CLEAR

SCLS376E - JUNE 1997 - REVISED JANUARY 2000

- *EPIC*[™] (Enhanced-Performance Implanted CMOS) Process
- Operating Range 2-V to 5.5-V V_{CC}
- Contain Eight Flip-Flops With Single-Rail Outputs
- Direct Clear Input
- Individual Data Input to Each Flip-Flop
- Applications Include:
 - Buffer/Storage Registers
 - Shift Registers
 - Pattern Generators
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

description

These circuits are positive-edge-triggered D-type flip-flops with a direct clear (CLR) input.

Information at the data (D) inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When CLK is at either the high or low level, the D input has no effect at the output.

The SN54AHC273 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74AHC273 is characterized for operation from –40°C to 85 °C.

FUNCTION TABLE (each flip-flop) INPUTS UR CLK D Q

CLR	CLK	D	Q
L	Х	Х	L
н	Ŷ	Н	н
н	Ŷ	L	L
Н	L	Х	Q ₀



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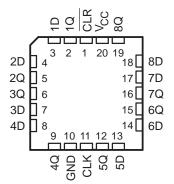
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SN54AHC273 ... J OR W PACKAGE SN74AHC273 ... DB, DGV, DW, N, OR PW PACKAGE (TOP VIEW)

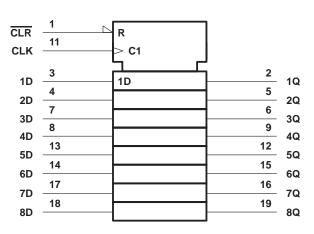
SN54AHC273 . . . FK PACKAGE (TOP VIEW)



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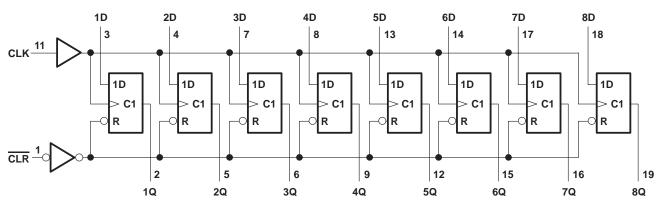
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logic symbol[†]

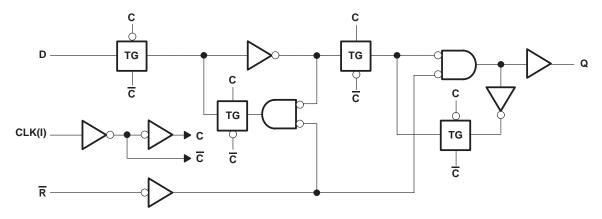


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



logic diagram, each flip-flop (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}		
Input voltage range, V _I (see Note 1)		–0.5 V to 7 V
Output voltage range, V _O (see Note 1)		–0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)		
Output clamp current, I_{OK} (V _O < 0 or V _O > V		
Continuous output current, $I_O (V_O = 0 \text{ to } V_C O$	с)	±25 mA
Continuous current through V _{CC} or GND		±75 mA
Package thermal impedance, θ_{JA} (see Note	2): DB package	
	DGV package	
	DW package	58°C/W
Storage temperature range, T _{stg}		

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed. 2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

			SN54A	HC273	SN74A	HC273		
			MIN	MAX	MIN MAX		UNIT	
VCC	Supply voltage		2	5.5	2	5.5	V	
		V _{CC} = 2 V	1.5		1.5			
VIH	High-level input voltage	$V_{CC} = 3 V$	2.1		2.1		V	
		$V_{CC} = 5.5 V$	3.85		3.85			
		$V_{CC} = 2 V$		0.5		0.5		
VIL	Low-level input voltage	$V_{CC} = 3 V$		0.9		0.9	V	
		V _{CC} = 5.5 V		1.65		1.65		
VI	Input voltage	-	0	5.5	0	5.5	V	
VO	Output voltage		0	VCC	0	VCC	V	
		V _{CC} = 2 V		-50		-50	μΑ	
IOH	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4		-4		
		$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$		-8 -8			mA	
		$V_{CC} = 2 V$		50		50	μΑ	
IOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	mA	
		$V_{CC} = 5 V \pm 0.5 V$		8		8	MA	
Δt/Δv	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	ns/V	
Δ0/ΔV	Input transition rise or fall rate	$V_{CC} = 5 V \pm 0.5 V$		20		20	115/ V	
ТА	Operating free-air temperature	-	-55	125	-40	85	°C	

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vee	Т	λ = 25°C	;	SN54A	HC273	SN74AHC273		UNIT	
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
		2 V	1.9			1.9		1.9			
	I _{OH} = -50 μA	3 V	2.9			2.9		2.9			
VOH		4.5 V	4.4			4.4		4.4		V	
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48			
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8			
		2 V			0.1		0.1		0.1		
	I _{OL} = 50 μA	3 V			0.1		0.1		0.1		
VOL		4.5 V			0.1		0.1		0.1	V	
	I _{OL} = 4 mA	3 V			0.36		0.5		0.44		
	I _{OL} = 8 mA	4.5 V			0.36		0.5		0.44		
lj	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1*		±1	μA	
ICC	$V_{I} = V_{CC} \text{ or GND}, I_{O} = 0$	5.5 V			4		40		40	μΑ	
Ci	$V_I = V_{CC}$ or GND	5 V		2.5	10				10	pF	

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

			SN54AHC273			SN74AHC273						
			T _A = 2	T _A = 25°C		MAX	T _A = 25°C		MIN		UNIT	
			MIN	MAX	MIN	WAA	MIN	MAX	WIIN	MAX		
t Pulso dura	Pulse duration	CLR low	5		6		5		6			
tw	Fuise duration	CLK high or low	5		6.5		5		6.5		ns	
	Out out the	Data before CLK↑	5.5		6.5		5.5		6.5			
tsu	Setup time	CLR before CLK↑	2.5		2.5		2.5		2.5		ns	
t _h	Hold time, data after CLK↑		1.5		2		1		1		ns	

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

				SN54AHC273				SN74AHC273			
			T _A = 2	25°C	MIN MAX		T _A = 25°C		MIN	МАХ	UNIT
			MIN			MIN	MAX				
t Dulas duras	Pulse duration	CLR low	5		5		5		5		ns
tw	Fuise duration	CLK high or low	5		5		5		5		115
	Catura timo	Data before CLK↑	4.5		4.5		4.5		4.5		
t _{su}	Setup time	CLR before CLK1	2		2		2		2		ns
th	Hold time, data after CLK^\uparrow		1.5		2		1		1		ns



switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C			SN54A	HC273	SN74AHC273		UNIT				
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT				
4			C _L = 15 pF	75*	120*		65*		65		MHz				
fmax			C _L = 50 pF	50	75		45		45						
^t PHL	CLR	Q	C _L = 15 pF		8.9*	13.6*	1*	16*	1	16	ns				
^t PLH	CLK		Ci = 15 pE		8.7*	13.6*	1*	16*	1	16					
^t PHL	CLK	Q	C _L = 15 pF		8.7*	13.6*	1*	16*	1	16	ns				
^t PHL	CLR	Q	C _L = 50 pF		11.4	17.1	1	19.5	1	19.5	ns				
^t PLH	<u>our</u>	<u> </u>	0. 50 pF		11.2	17.1	1	19.5	1	19.5					
^t PHL	CLK	CLK	ULK	ULK	ULK	Q	C _L = 50 pF		11.2	17.1	1	19.5	1	19.5	ns
^t sk(o)			C _L = 50 pF			1.5**				1.5	ns				

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	Т	₄ = 25°C	;	SN54A	HC273	SN74AI	UNIT		
PARAMETER	(INPUT) ((OUTPUT) CAPACITANCE			MAX	MIN	MAX	MIN	MAX		
4			C _L = 15 pF	120*	165*		100*		100		MHz	
fmax			C _L = 50 pF	80	110		70		70		IVITIZ	
^t PHL	CLR	Q	C _L = 15 pF		5.2*	8.5*	1*	10*	1	10	ns	
^t PLH	CLK	CLK	0	C _I = 15 pF		5.8*	9*	1*	10.5*	1	10.5	ns
^t PHL			OEK	Q	CL = 15 pr		5.8*	9*	1*	10.5*	1	10.5
^t PHL	CLR	Q	C _L = 50 pF		6.7	10.5	1	12	1	12	ns	
^t PLH	CLK		$C_{1} = 50 \text{ pF}$		7.3	11	1	12.5	1	12.5		
^t PHL	CLK	ULK	Q	Q $C_{L} = 50 \text{pF}$		7.3	11	1	12.5	1	12.5	ns
^t sk(o)			C _L = 50 pF			1**				1	ns	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

	PARAMETER	SN7	UNIT		
	FARAMETER	MIN	TYP	MAX	UNIT
VOL(P)	Quiet output, maximum dynamic V _{OL}		0.7		V
VOL(V)	Quiet output, minimum dynamic V _{OL}		-0.7		V
VOH(V)	Quiet output, minimum dynamic V _{OH}		4.7		V
VIH(D)	High-level dynamic input voltage	3.5			V
V _{IL(D)}	Low-level dynamic input voltage			1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

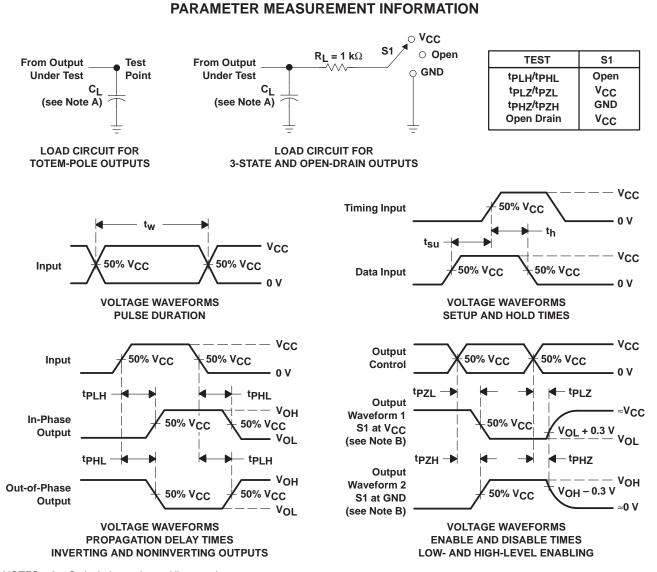
operating characteristics, T_A = 25°C

	PARAMETER	TEST CO	ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	31	pF



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NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

- Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 3 ns, t_f \leq 3 ns. D. The outputs are measured one at a time with one input transition per measurement.

. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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